Tyrone Camarero Specifications

Camarero DS300TN-110R

Key features

- Dual socket R3 (LGA 2011) supports Intel® Xeon® processor E5-2600v4/ v3 family
- Intel® C612 chipset
- Up to 2TB ECC 3DS LRDIMM, up to DDR4- 2400 MHz; 16x DIMM slots
- 2x PCI-E 3.0 x16 (FHHL) slots
- 10x Hot-swap 2.5" SAS/SATA HDD bays; 2x NVMe support
- Intel® i350-AM2 Dual port GbE LAN
- I/O ports: 2x SuperDOM, 1x VGA, 1x COM, 2x USB 3.0 (front),4x USB 2.0 (rear)\
- 2x SuperDOM (Disk on Module) ports
- 700W Redundant Power Supplies Platinum Level High-efficiency









Processor/Cache

Dual socket R3 (LGA 2011) supports Intel® Processor

Xeon® processor E5-2600v4/v3 family

Chipset

Intel® C612 chipset Chipset

System Memory

Memory Capacity 16x 288-pin DDR4 DIMM slots,Up to 2TB

ECC 3DS LRDIMM, 512GB ECC RDIMM

Expansion Slots

PCI-Express 2x PCI-E 3.0 x16 full-height, half-length

Integrated On-Board

SATA SATA3 (6Gbps); RAID 0, 1, 5, 10

LAN 2x RJ45 Gigabit Ethernet LAN ports,

1x RJ45 Dedicated IPMI LAN port

Add-on Options

Raid Optional

Optical Drive None

Front Panel

LED Indicators Power status LED HDD activity LED,

2x Network activity LEDs Universal

Information (UID) LED

Buttons Power On/Off button UID button

Drive Bays

8x SATA3 (6Gbps) ports and 2x NVMe/STAT3 Hotswap

hybrid ports (connected to onboard storage

controller)

Power Supply

700W Redundant Power Supplies Platinum Level High-efficiency

Cooling System

5x 4cm heavy-duty counter-rotating fans w/ air shroud and

optimal fan speed control

Form Factor

1U Rackmountable Form Factor

Width 17.2" (437mm), 1.7" (43mm), Height 23.5" (597mm) Depth

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For more/current product information, visit

www.tyronesystems.com

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